

HX4066-S 四双向模拟开关

概况

HX4066-S 提供四个单极、单掷模拟开关功能。每个开关都有两个输入/输出端子 (nY 和 nZ) 和一个主动的 HIGH 启用输入 (nE)。当 nE 较低时，模拟开关被关闭。

主要特点

宽电源电压范围从 3V 到 9V

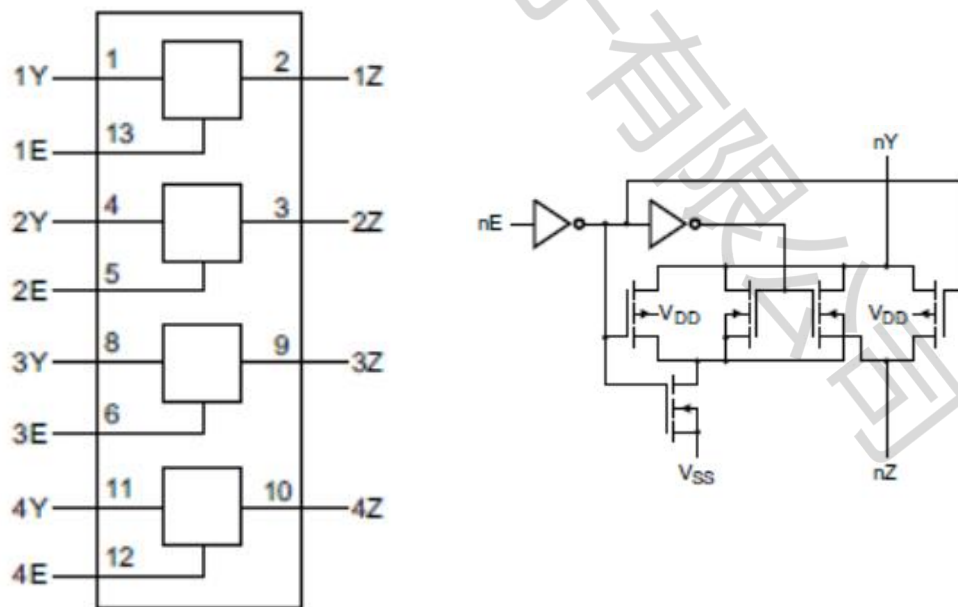
全静态运行

5 V 和 9V 参数额定值

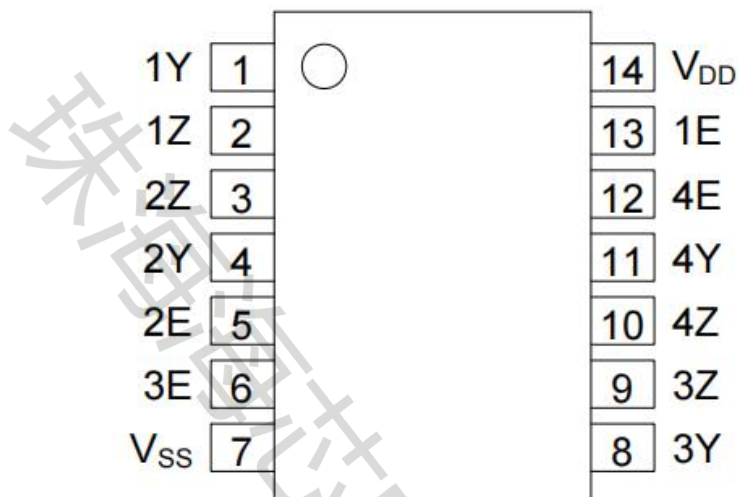
标准化对称输出特性

指定从 -40°C 到 +125°C

逻辑图



Pin Configurations



Pin No.	Pin Name	Description
1	1Y	independent input or output
2	1Z	independent input or output
3	2Z	independent input or output
4	2Y	independent input or output
5	2E	enable input (active HIGH)
6	3E	enable input (active HIGH)
7	V _{ss}	ground (0V)
8	3Y	independent input or output
9	3Z	independent input or output
10	4Z	independent input or output
11	4Y	independent input or output
12	4E	enable input (active HIGH)
13	1E	enable input (active HIGH)
14	V _{DD}	supply voltage

Function Table

Input	Switch
nE	
H	ON
L	OFF

Note: H=HIGH voltage level; L=LOW voltage level.

Electrical Parameter

Absolute Maximum Ratings

(Voltages are referenced to V_{SS} (ground=0V), unless otherwise specified.)

Parameter	Symbol	Conditions	Min.	Max.	Unit
supply voltage	V_{DD}	-	-0.5	+12	V
input voltage	V_I	-	-0.5	$V_{DD}+0.5$	V
input clamping current	I_{IK}	$V_I < 0.5V$ or $V_I > V_{DD}+0.5V$	-	± 10	mA
input/output current	$I_{I/O}$	-	-	± 10	mA
storage temperature	T_{stg}	-	-65	+150	°C
total power dissipation	P_{tot}	-	-	500	mW
device dissipation	P	per output transistor	-	100	mW

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Recommended Operating Conditions

($T_{amb}=25^{\circ}\text{C}$; $R_L=10\text{k}\Omega$; $C_L=50\text{pF}$; $nE=V_{DD}$; $Vis=V_{DD}=5\text{V}$.)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
supply voltage	V_{DD}	-	3	5	9	V
ambient temperature	T_{amb}	in free air	-40	-	+125	$^{\circ}\text{C}$
input voltage	V_I	-	0	-	V_{DD}	V
Disable output time (High level→turnoff)	t_{PHZ}	nE to nZ or nE to nY	-	80	160	ns
Disable output time (Low level→turnoff)	t_{PLZ}	nE to nZ or nE to nY	-	80	160	ns
Enable output time (turnoff→high/low level)	t_{PZH}, t_{PZL}	-	-	45	90	ns
input capacitance	C_I	-	-	-	7.5	pF

Electrical Characteristics

DC Characteristics 1

($T_{amb}=25^{\circ}\text{C}$, voltages are referenced to V_{SS} (ground=0V), unless otherwise specified.)

Parameter	Symbol	Conditions (V)		T _{amb} =25 °C			Unit
				Min.	Typ.	Max.	
supply current	I _{DD}	V _I =V _{DD} or V _{SS} , I _O =0A	V _{DD} =5V	-	-	1.0	uA
			V _{DD} =9V	-	-	2.0	uA
HIGH-level input voltage	V _{IH}	I _O <1uA	V _{DD} =5V, V _O =0.5V or 4.5V	3.5	-	-	V
			V _{DD} =9V, V _O =0.5V or 8V	7.0	-	-	V
LOW-level input voltage	V _{IL}	I _O <1uA	V _{DD} =5V, V _O =0.5V or 4.5V	-	-	1.5	V
			V _{DD} =9V, V _O =0.5V or 8V	-	-	3.0	V
input leakage current	I _I	V _I =0V or 9V, V _{DD} =9V		-	-	1.0	uA
		V _I =0V to V _{DD} -V _{EE}	V _{DD} -V _{EE} =5V	-	350	2500	Ω
			V _{DD} -V _{EE} =9V	-	80	245	Ω

ON resistance (rail)	R_{ON}	$V_I=0V$	$V_{DD}-V_{EE}=5V$	-	115	340	Ω
			$V_{DD}-V_{EE}=9V$	-	50	160	Ω
		$V_I=V_{DD}-V_{EE}$	$V_{DD}-V_{EE}=5V$	-	120	365	Ω
			$V_{DD}-V_{EE}=9V$	-	65	200	Ω
ON resistance mismatch between channels	ΔR_{ON}	$V_I=0V$ to $V_{DD}-V_{EE}$	$V_{DD}-V_{EE}=5V$	-	25	-	Ω
			$V_{DD}-V_{EE}=9V$	-	10	-	Ω

DC Characteristics 2

($T_{amb}=-40^{\circ}C$ to $+85^{\circ}C$, voltages are referenced to V_{SS} (ground=0V), unless otherwise specified.)

Parameter	Symbol	Conditions (V)		T _{amb} =-40℃		T _{amb} =+85℃		Unit
				Min.	Max.	Min.	Max.	
supply current	I _{DD}	V _I =V _{DD} or V _{SS} , I _O =0A	V _{DD} =5V	-	1.0	-	7.5	uA
			V _{DD} =9V	-	2.0	-	15.0	uA
HIGH-level input voltage	V _{IH}	I _O <1uA	V _{DD} =5V, V _O =0.5V or 4.5V	3.5	-	3.5	-	V
			V _{DD} =9V, V _O =0.5V or 8V	7.0	-	7.0	-	V
LOW-level input voltage	V _{IL}	I _O <1uA	V _{DD} =5V, V _O =0.5V or 4.5V	-	1.5	-	1.5	V
			V _{DD} =9V, V _O =0.5V or 8V	-	3.0	-	3.0	V
input leakage current	I _I	V _I =0V or 9V, V _{DD} =9V		-	-	-	1.0	uA

DC Characteristics 3

($T_{amb}=-40^{\circ}C$ to $+125^{\circ}C$, voltages are referenced to V_{SS} (ground=0V), unless otherwise specified.)

Parameter	Symbol	Conditions (V)		T _{amb} =-40℃		T _{amb} =+125℃		Unit
				Min.	Max.	Min.	Max.	
supply current	I _{DD}	V _I =V _{DD} or V _{SS} , I _O =0A	V _{DD} =5V	-	1.0	-	7.5	uA
			V _{DD} =9V	-	2.0	-	15.0	uA

HIGH-level input voltage	V_{IH}	$ I_o < 1\mu A$	$V_{DD}=5V$, $V_O=0.5V$ or $4.5V$	3.5	-	3.5	-	V
			$V_{DD}=9V$, $V_O=0.5V$ or $8V$	7.0	-	7.0	-	V
LOW-level input voltage	V_{IL}	$ I_o < 1\mu A$	$V_{DD}=5V$, $V_O=0.5V$ or $4.5V$	-	1.5	-	1.5	V
			$V_{DD}=9V$, $V_O=0.5V$ or $8V$	-	3.0	-	3.0	V
input leakage current	I_I	$V_I=0V$ or $9V$, $V_{DD}=9V$		-	-	-	1.0	μA

AC Characteristics 1

($T_{amb}=25^\circ C$, $V_{EE}=V_{SS}=0V$, t_r , $t_f \leq 20ns$, $C_L=50pF$, $R_L=10k\Omega$, unless otherwise specified.)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit	
HIGH to LOW propagation delay time	t_{PHL}	nY to nZ; nZ tonY; see Figure 4	$V_{DD}=5V$	-	10	20	ns
			$V_{DD}=9V$	-	5	10	ns
LOW to HIGH propagation delay	t_{PLH}	nY to nZ; nZ tonY; see Figure 4	$V_{DD}=5V$	-	10	20	ns
			$V_{DD}=9V$	-	5	10	ns
HIGH to OFF-state propagation delay	t_{PHZ}	nE tonY, nZ; see Figure 5	$V_{DD}=5V$	-	80	160	ns
			$V_{DD}=9V$	-	65	130	ns
LOW to OFF-state propagation delay	t_{PLZ}	nE tonY, nZ; see Figure 5	$V_{DD}=5V$	-	80	160	ns
			$V_{DD}=9V$	-	70	140	ns
OFF-state to HIGH propagation delay	t_{PZH}	nE tonY, nZ; see Figure 5	$V_{DD}=5V$	-	40	80	ns
			$V_{DD}=9V$	-	20	40	ns
OFF-state to LOW propagation	t_{PZL}	nE tonY, nZ; see	$V_{DD}=5V$	-	45	90	ns
			$V_{DD}=9V$	-	20	40	ns

delay		Figure 5					
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AC Characteristics 2

($T_{amb}=25^{\circ}\text{C}$, $V_{EE}=V_{SS}=0\text{V}$, $V_I=0.5V_{DD}$ (p-p), unless otherwise specified.)

Parameter	Symbol	Conditions		Min.	Typ.	Max.	Unit
Square wave distortion	d_{sin}	see Figure 6; $R_L=10k\Omega$; $C_L=15pF$; channel ON; $f_i=1kHz$	$V_{DD}=5V$	0.25	-	-	%
			$V_{DD}=9V$	0.04	-	-	%
any two channel crosstalk	f_{ct}	$V_{DD}=9V$, see note2		1	-	-	MHz
crosstalk voltage (nE to nY to nZ)	V_{ct}	see Figure 7; $R_L=10k\Omega$; $C_L=15pF$; E^- or $Sn=V_{DD}$ (square-wave)		50	-	-	mV
OFF frequency	f_{OFF}	$V_{DD}=9V$, see note3		1	-	-	MHz
conduction frequency	f_{ON}	$V_{DD}=5V$, see note4		-	-	-	MHz
		$V_{DD}=9V$, see note4		90	-	-	MHz

Note:

[1] f_i is biased at $0.5V_{DD}$; $V_I=0.5V_{DD}$ (p-p).

[2] $R_L=1\text{k}\Omega$; $20\log V_{os}/V_{is}=-50\text{dB}$, see Figure 8.

[3] $R_L=1\text{k}\Omega$; $C_L=5\text{pF}$, channel off, $20\log V_{os}/V_{is}=-50\text{dB}$, see Figure 6.

[4] $R_L=1\text{k}\Omega$; $C_L=5\text{pF}$, channel on, $20\log V_{os}/V_{is}=-3\text{dB}$, see Figure 6.

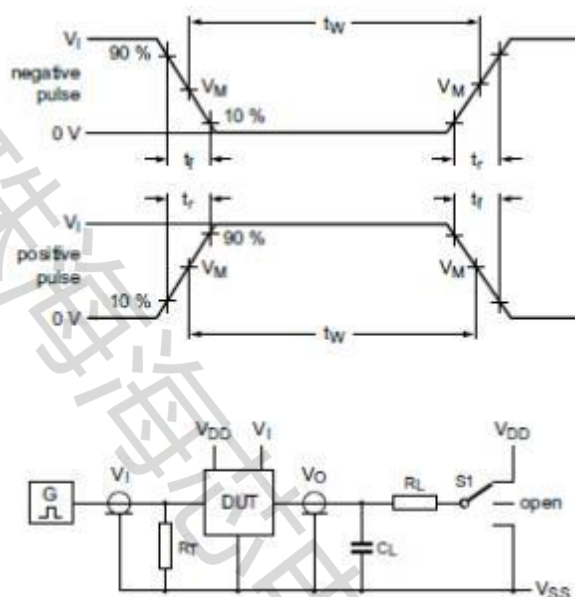


Figure 3. Test circuit for switching times

Definitions for
test circuit:

DUT=Device

Under Test.

C_L =Load capacitance including jig and probe capacitance.

R_T =Termination resistance should be equal to the output impedance Z_o of the pulse generator. R_L =Load resistance.

AC Testing Waveforms

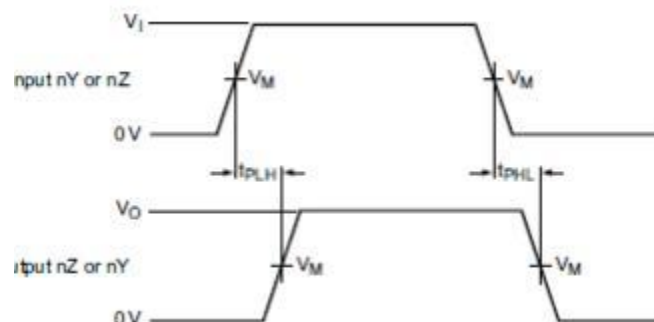


Figure 4. nY or nZ to nZ or nY propagation delays

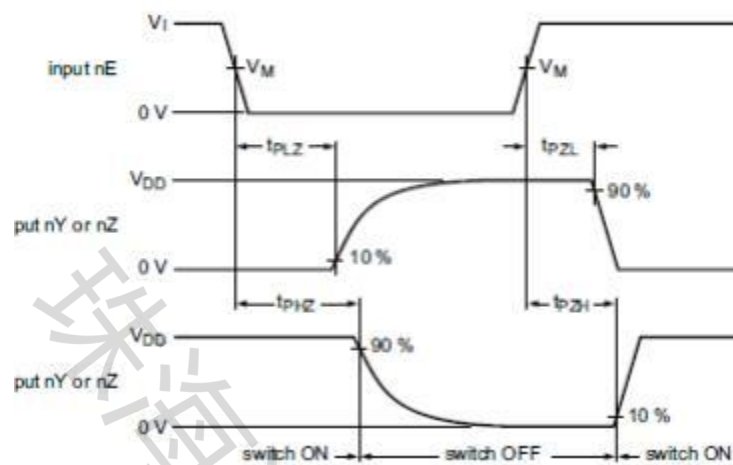
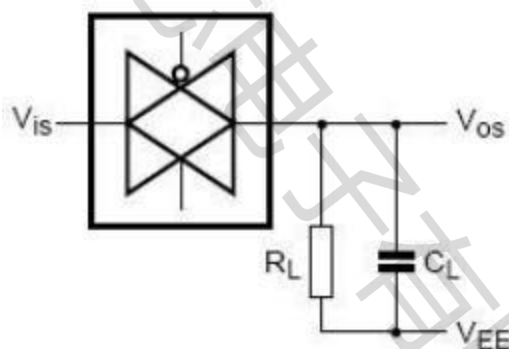


Figure 5. Enable and disable times

AC Testing Circuit 2



Square wave distortion degree of cut-off frequency and conduction frequency test pattern

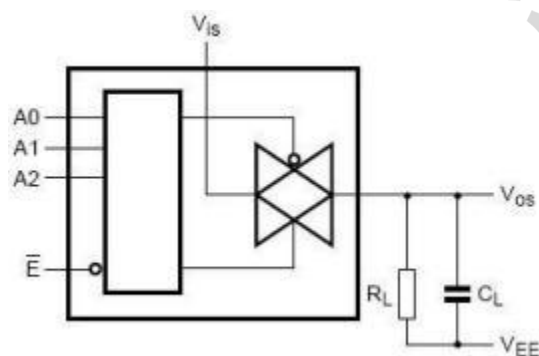


Figure 7. Crosstalk logical input/output test

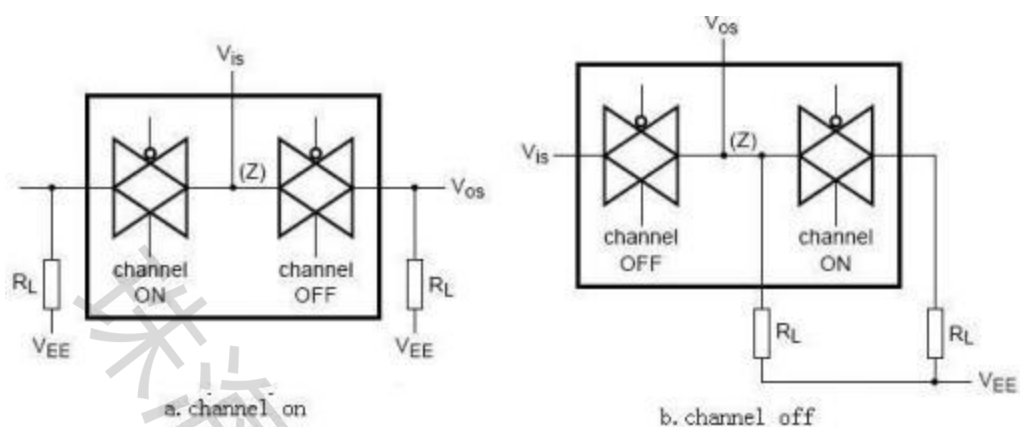


Figure 8. Inter channel Crosstalk

On Resistance Waveform And Test Circuit

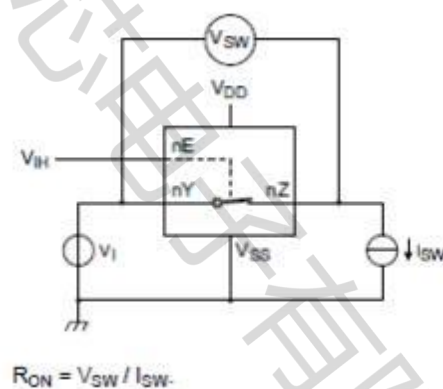


Figure 9. Test circuit for measuring R_{ON}

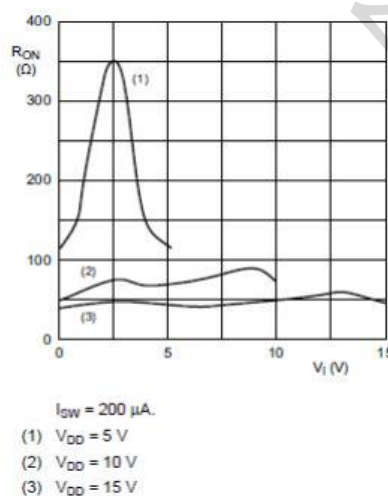
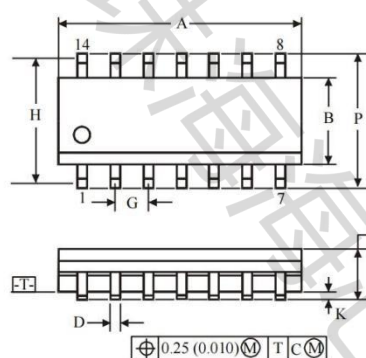


Figure 10. Typical R_{ON} as a function of input voltage

封装

SOP14 (Package Outline Dimensions)

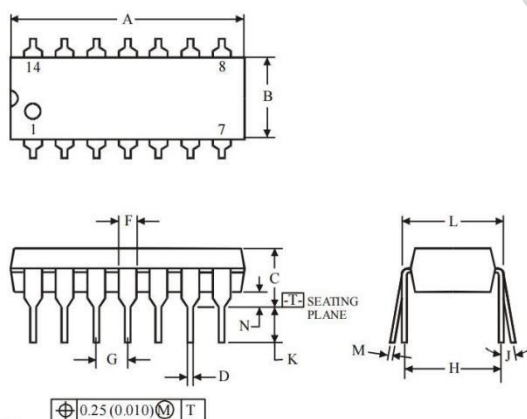


NOTES:

1. Dimensions A and B do not include mold flash or protrusion.
2. Maximum mold flash or protrusion 0.15 mm (0.006) per side for A; for B - 0.25 mm (0.010) per side.

Symbol	Dimension, mm	
	MIN	MAX
A	8.55	8.75
B	3.8	4
C	1.35	1.75
D	0.33	0.51
F	0.4	1.27
G	1.27	
H	5.27	
J	0°	8°
K	0.1	0.25
M	0.19	0.25
P	5.8	6.2
R	0.25	0.5

DIP14 (Package Outline Dimensions)



NOTES:

1. Dimensions "A", "B" do not include mold flash or protrusions.
Maximum mold flash or protrusions 0.25 mm (0.010) per side.

Symbol	Dimension, mm	
	MIN	MAX
A	18.67	19.69
B	6.1	7.11
C	5.33	
D	0.36	0.56
F	1.14	1.78
G	2.54	
H	7.62	
J	0°	10°
K	2.92	3.81
L	7.62	8.26
M	0.2	0.36
N	0.38	

Part Number	Package Type	Package	quantity
HX4066-S	SOP-14	Taping	2500